

Evaluation board for STDRIVEG611 600 V high-speed half-bridge gate driver with SGT120R65AL e-mode GaN HEMT



- Half-bridge topology featuring the STDRIVEG611 GaN gate driver with integrated LDOs, separated sink/source, overcurrent protection, integrated bootstrap diode, standby
- Equipped with 75 mΩ typ., 650 V e-mode HEMT GaN
- Tunable hard-on and hard-off dV/dt, set at 10 V/ns typ. for motor control applications
- 10.6 to 18 V (12 V typ.) VCC supply voltage
- Onboard adjustable deadtime generator to convert a single PWM signal in independent high-side and low-side inputs with deadtime
- Separated inputs with external deadtime can also be used
- Programmable overcurrent protection with SmartShutDown, set at 9.5 A
- Footprint for, optional, additional high-voltage bulk capacitor and bootstrap diode
- Onboard 3.3 V regulator for external circuitry supply
- RoHS compliant.



Product status link

EVLSTDRIVEG611

Description

The STDRIVEG611 is a high-speed, half-bridge gate driver optimized to drive high-voltage, enhanced mode, GaN HEMTs.

It features separated high current sink/source gate driving pins, integrated LDOs, undervoltage, bootstrap diode, overcurrent protection with SmartShutDown, overtemperature, fault and shutdown pins, and standby to fully support hard switching topologies in a 4x5mm QFN package.

The EVLSTDRIVEG611 board is easy to use and quick and adapt for evaluating the characteristics of the STDRIVEG611 driving the SGT120R65AL 75 m Ω typ., 650 V E-Mode GaN switches in the 5x6 mm QFN package.

It provides an onboard programmable deadtime generator and a 3.3 V linear voltage regulator to supply external logic like microcontrollers.

Spare footprints are also included to allow customizing the board for the final application, such as separate LIN and HIN input signals or single PWM signal.

The EVLSTDRIVEG611 is 56 x 70 mm wide, 2 layers, 2 Oz, FR-4 PCB, resulting in 23 °C/W $R_{th(J-A)}$ (equivalent to 46 °C/W for each GaN) in still air to evaluate high power applications.



Attention:

Important:

1 Safety and operating instructions



1.1 General terms

Warning: During assembly, testing, and operation, the evaluation board poses several inherent hazards, including bare wires, moving or rotating parts, and hot surfaces.

Danger: There is a danger of serious personal injury, property damage, or death due to electrical shock and burn hazards if the kit or components are improperly used or installed incorrectly.

The kit is not electrically isolated from the high-voltage supply DC input. No insulation is ensured between the accessible parts and the high voltage. All measuring equipment must use adequately insulated probes, clamps, and connecting wires. Never touch the evaluation board while it is energized as it is capable of causing an electrical shock hazard.

All operations involving transportation, installation and use, and maintenance must be performed by skilled technical personnel able to understand and implement national accident prevention regulations. For the purposes of these basic safety instructions, "skilled technical personnel" are suitably qualified people who are familiar with the installation, use, and maintenance of power electronic systems.

1.2 Intended use of evaluation board

The evaluation board is designed for demonstration purposes only, and must not be used for electrical installations or machinery. Technical data and information concerning the power supply conditions are detailed in the documentation and should be strictly observed.

1.3 Installing the evaluation board

- The installation and cooling of the evaluation board must be in accordance with the specifications and target application.
- The board must be protected against excessive strain. In particular, components should not be bent nor should isolating distances be altered during transportation or handling.
- No contact must be made with other electronic components and contacts.
- The board contains electrostatically sensitive components that are prone to damage if used incorrectly. Do not mechanically damage or destroy the electrical components (potential health risks).

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Operating the evaluation board

To properly operate the board, follow these safety rules.

- 1. Work area safety:
 - The work area must be clean and tidy.
 - Do not work alone when boards are energized.
 - Protect against inadvertent access to the area where the board is energized using suitable barriers and
 - A system architecture that supplies power to the evaluation board must be equipped with additional control and protective devices in accordance with the applicable safety requirements (that is, compliance with technical equipment and accident prevention rules).
 - Use a non-conductive and stable work surface.
 - Use adequately insulated clamps and wires to attach measurement probes and instruments.

2. Electrical safety:

- Remove the power supply from the board and electrical loads before taking any electrical measurements.
- Proceed with the arrangement of measurement setup, wiring, or configuration paying attention to highvoltage sections.
- Once the setup is complete, energize the board.

Danger: Do not touch the board when it is energized or immediately after it has been disconnected from the voltage supply as several parts and power terminals containing potentially energized capacitors need time to discharge.

> Do not touch the board after disconnection from the voltage supply as several parts, included PCB, may still be very hot.

The kit is not electrically isolated from DC input.

3. Personal safety

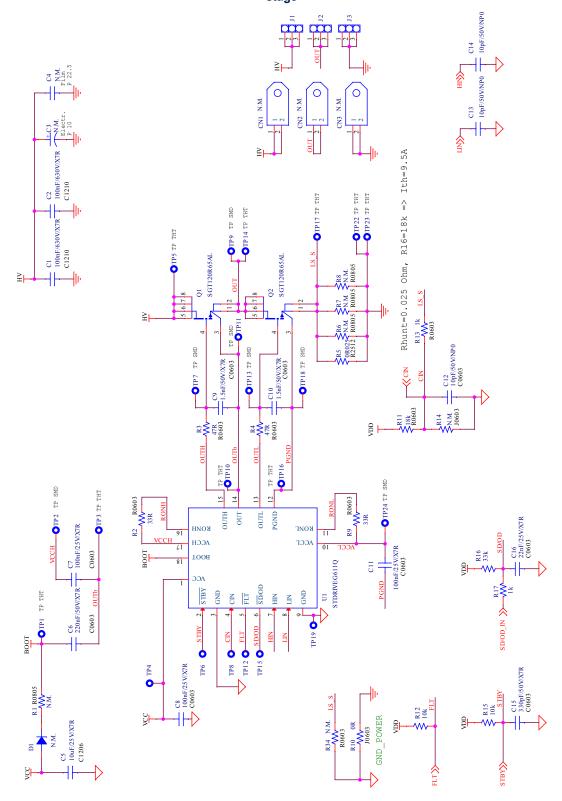
- Always wear suitable personal protective equipment such as insulating gloves and safety glasses.
- Take adequate precautions and install the board in such a way to prevent accidental touch. Use protective shields such as, for example, an insulating box with interlocks if necessary.

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2 Schematic diagrams

Figure 1. EVLSTDRIVEG611 schematic - STDRIVEG611 gate driver and SGT120R65AL e-mode GaN power stage



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OTP25 VDD 3.3V 1 2 3 4 5 6 7 8 8 9 10 11 R19 R18 0R J0603 0R J0603 STBY CIN U2 ST715MR OUT R20 205k R0603 GND FB C18 C0603 1uF/10V/X7R C19 1uF/10V/X7R ю C0603 100nF/25V/X7R HIN_skt R23 N.M. J0603 C20 C0603 VDT R24 47R R0603 D2 BAT54J R25 0R J0603 A N B GND Y 74LVC1G86Q XOR C21 1nF/50V/X7R C0603 TRI HS DT VDT $\begin{array}{c} R28 \\ 0R \\ J0603 \end{array} \text{PWM} \; --> \; \text{HIN}$ R30 47R R0603 D3 BAT54J C22 | C0603 R31 0R J0603 100nF/25V/X7R U4 R32 N.M. J0603 C23 InF/50V/X7R C0603 VCC GND R33 47k R0603 TR2 1K 1K 74LVIT87GV XNOR

Figure 2. EVLSTDRIVEG611 schematic - deadtime generator and connectors

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3 Board power-up and input connection

The following image shows how to supply the EVLSTDRIVEG611, how to provide LIN and HIN inputs and set the programmable deadtime generator.

J5: 12V typ gate driver supply VCC GND TR1: High-side deadtime generator J2: OUT, Half-bridge middle point J1: HV BUS **Direct LIN & HIN inputs** (see Table 2) Single signal input for deadtime generator J3: POWER GROUND J4: Driver supply and inputs connector J1 & J3: Half bridge TR2: Low-side Single PWM input selecto high voltage supply deadtime generator Direct LIN & HIN inputs selector

Figure 3. EVLSTDRIVEG611 - supply and signal connection

The LIN, HIN inputs can be provided from the onboard deadtime generator or directly from an external generator or control device (such as DSP/MCU).

The deadtime value set by the onboard deadtime generator, fed by PWM input signal on J4, can be tuned by setting TR1 and TR2. The typical deadtime value with the trimmer in the default manufacturing middle position is about 700 ns.

It is possible to change the deadtime generator range by changing C21 and C23. Polarity of PWM input can be modified with R27 and R28 as in Table 3.

TR2 sets the deadtime between high-side turn-off and low-side turn-on.

TR1 sets the deadtime between low-side turn-off and high-side turn-on.

Pin# Ref Name **Function** Description 1 VCC IN power Board supply voltage (12 V typ.) Output voltage of onboard 3.3 V (adj.) regulator: it can be used to 2 VDD (3V3) **OUT** power supply external circuitry (up to about 50 mA) 3 **STBY** IN digital Standby input signal (active low) CIN **OUT** analog Low-side current sense resistor voltage 4 FLT 6 **OUT** digital Fault output (overcurrent, UVLO, overtemperature) Disable input signal (0 to 3.3 V or up to 20 V) – see Table 3. .14 IN digital / 7 SD/OD Open-drain output to set the disable time after an overcurrent **OUT** analog event (default ~1 ms). HIN direct input signal (0 to 3.3 V or up to 20 V): mount R23 and HIN 9 IN digital remove R25 - see Table 2 and Table 3 LIN direct input signal (0 to 3.3 V or up to 20 V): mount R29 and 10 LIN IN digital remove R31 - see Table 2 and Table 3 12 **PWM** IN digital PWM input signal (0 to 3.3 V or 5 V) - see Table 2 and Table 3

Table 1. Connector map

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Ref	Pin#	Name	Function	Description
J4	5, 8, 11	GND	Power	Board reference potential
J2	1, 2, 3	OUT	OUT power	These three pins are connected to the OUT pin of the power stage: connect the load to this terminal
J1	1, 2, 3	HV	IN power	These three pins are connected to the high voltage (HV) of the GaN power stage. Connect the half-bridge high-voltage positive supply.
J3	1, 2, 3	GND_P	Power	These three pins are connected to power ground. Connect the half-bridge high-voltage negative supply.
J5	1	VCC	IN power	Board driver supply voltage 12 V typ. (as J4 pin 1)
33	2	GND	Power	Board reference potential

Table 2. Device input selection

Board status	Input source	R25, R31	R23, R29	Function and description
Default	PWM J4: pin 12	0 Ω (closed)	Open	LIN & HIN are generated by the onboard deadtime generator from a single PWM signal. PWM input range: 0 to 3.3 V (5 V compatible)
	PWM	Onen	0 Ω	Direct connection to LIN and HIN STDRIVEG611 pins.
	J4: pin 9, 10	Open	(closed)	LIN, HIN input range: up to 20 V

Table 3. Input signal truth table

Board inputs			PWM polarity	Driver inputs and outputs ⁽¹⁾				
STBY	SD/OD	PWM	R27, R28	LIN	HIN	Low-side	High-side	Half-bridge output
L	Х	x x	V	Х	Х	Off	Off	High 7
X	L		^	^	Oii		High-Z	
H (default, pull-up)	H (default, pull-up)	L	R27 open,	Н	L	On	Off	GND
		Н	R28 closed (default)	L	Н	Off	On ⁽²⁾	HV ⁽²⁾
		L	R27 closed,	L	Н	Off	On (2)	HV ⁽²⁾
		Н	R28 open	Н	L	On	Off	GND

^{1.} With device not in VCC and VCCL UVLO, $CIN < CIN_{th}$ and not in overtemperature.

The recommended power-on sequence is to turn VCC on first, then apply the HV bus voltage. The recommended power-off sequence is to turn off the HV bus supply first, then VCC.

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^{2.} With device not in VCCH UVLO



4 Bill of materials

Table 4. EVLSTDRIVEG611 bill of materials

Part reference	Part description	Part value	Package / manufacturer' code
CN1, CN2, CN3	Tab FASTON 250 horizontal	N.M.	
C1, C2	SMT ceramic capacitor	100 nF / 630 V / X7R	Size 1210
C3	THT electrolytic capacitor	N.M.	diam 22 mm, pitch 10 mm
C4	Plastic film capacitor	N.M	pitch 22.5 mm
			Size 1206
C5	SMT ceramic capacitor	10 μF / 25 V / X7R	Würth Elektronik 885012208069 or equivalent
			Size 0603
C6	SMT ceramic capacitor	220 nF / 50 V / X7R	Würth Elektronik 885012206125 or equivalent
C7, C8, C11, C19,			Size 0603
C20, C22	SMT ceramic capacitor	100 nF / 25 V / X7R	Würth Elektronik 885012206071 or equivalent
			Size 0603
C9, C10	SMT ceramic capacitor	1.5 nF / 50 V / X7R	Würth Elektronik 885012206084 or equivalent
			Size 0805
C12, C13, C14, C24	SMT ceramic capacitor	10 pF / 50 V / NP0	Würth Elektronik 885012006051 or equivalent
			Size 0603
C15	SMT ceramic capacitor	330 pF / 50 V / X7R	Würth Elektronik 885012206080 or equivalent
			Size 0603
C16	SMT ceramic capacitor	22 nF / 25 V / X7R	Würth Elektronik 885012206067 or equivalent
			Size 0603
C17, C18	SMT ceramic capacitor	1 μF / 10 V / X7R	Würth Elektronik 885012206026 or equivalent
		. = . =	Size 0603
C21, C23	SMT ceramic capacitor	1 nF / 50 V / X7R	Würth Elektronik 885012206083 or equivalent
D1	Turbo 2 ultrafast high-voltage rectifier	N.M.	SMA
	40 V, 300 mA small signal		SOD-323
D2, D3	Schottky diode	BAT54J	STMicroelectronics BAT54JFILM or
			equivalent
JP1	SMT jumper	OPEN	Soldering pads
J1, J2, J3	Strip connector	1x3 pins	Pitch 2.54 mm
			Würth Elektronik 61300311121 or equivalent
J4	Strip connector	1x12 pins	Pitch 2.54 mm
	Tamain at blood TULO 500		Würth Elektronik 61301211121 or equivalent
J5	Terminal block T.H. 2 pos, 5.08 mm	2 poles	Pitch 5.08 mm

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Part reference	Part description	Part value	Package / manufacturer' code
			Würth Elektronik 691213510002 or equivalent
J6	Ctrin connector	N.M.	Pitch 2.54 mm
30	Strip connector	IN.IVI.	Würth Elektronik 61300411121 or equivalent
Q1, Q2	Bottom-side cooled 650 V e-	SGT120R65AL	PowerFLAT 5x6 mm HV
Q1, Q2	mode GaN transistor	001120100AE	STMicroelectronics SGT120R65AL
R1, R6, R7, R8	SMT resistor	N.M.	Size 0805
R2, R9	SMT resistor	33 Ω	Size 0603
R3, R4, R24, R30	SMT resistor	47 Ω	Size 0603
R5	SMT resistor	25 mΩ	Size 2512
R10, R18, R19, R25, R28, R31	SMT resistor	0 Ω	Size 0603
R11	SMT resistor	18 kΩ	Size 0603
R12, R15	SMT resistor	10 kΩ	Size 0603
R13, R17	SMT resistor	1 kΩ	Size 0603
R14, R21, R23, R26, R27, R29, R32, R34	SMT resistor	N.M.	Size 0603
R16	SMT resistor	33 kΩ	Size 0603
R20	SMT resistor	205 kΩ	Size 0603
R22	SMT resistor	120 kΩ	Size 0603
R33	SMT resistor	47 kΩ	Size 0603
TP1, TP3, TP4, TP5, TP6, TP8, TP10, TP12, TP14, TP15, TP16, TP17, TP19, TP22, TP23, TP25	Test point for probe	-	Metallized Hole, 0.8 mm diameter
TP2, TP7, TP11, TP13, TP18, TP24	Test point	-	Copper PAD, 1.016 mm diameter
TP9	Test point	-	Copper PAD, 1.27 mm diameter
TR1, TR2	Surface Mount Miniature Trimmers Multi-Turn Cermet Sealed	1 kΩ	Square 5 mm Vishay TSM4YJ
U1	High-voltage, high-speed half- bridge GaN gate driver	STDRIVEG611	QFN18 4x5 mm STMicroelectronics STDRIVEG610Q
U2	High input voltage, 85 mA LDO linear regulator	ST715MR	SOT23-5L STMicroelectronics ST715MR or equivalent
U3	2- inputs EXCLUSIVE-OR gate	74LVC1G86Q	SOT23-5L Diodes incorporeted 74LVC1G86QW5-7 orequivalent
U4	2-inputs EXCLUSIVE-NOR gate	74LV1T87GV	SOT23-5L Nexperia 74LV1T87GV or equivalent

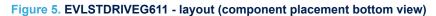
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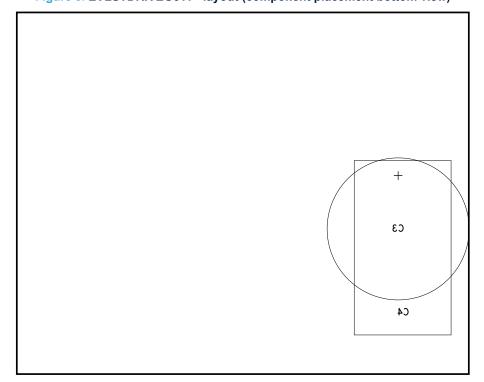


Layout and component placements

TP25○□ C20□ C21 R22 B23 C6□ R11□□ R12□□ TP10 TP7 OTP9 TP5O C1 C2 C220 P19 R34 R130 R130 TP8 TP6 TP12O TP15 C24 R33 TP22 () TP23 () TR2 TP17 R5 R7

Figure 4. EVLSTDRIVEG611 - layout (component placement top view)





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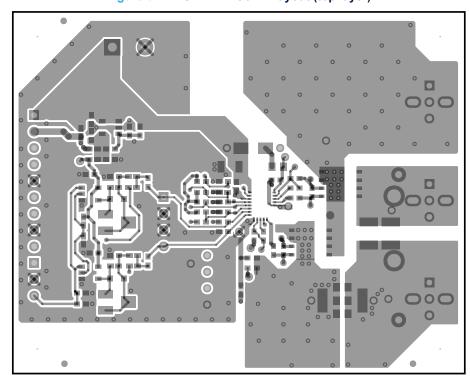
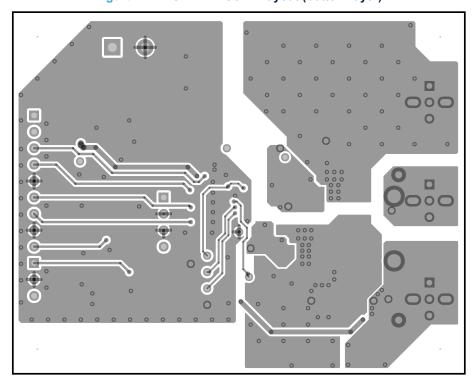


Figure 6. EVLSTDRIVEG611 - layout (top layer)





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Revision history

Table 5. Document revision history

Date	Version	Changes
03-Sep-2024	1	Initial release.

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